onsemi

MOSFET – Power, Single N-Channel, STD Gate, SO8FL

80 V, 1.9 mΩ, 201 A

NTMFS2D1N08X

Features

- Low QRR, Soft Recovery Body Diode
- Low R_{DS(on)} to Minimize Conduction Losses
- Low QG and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Synchronous Rectification (SR) in DC-DC and AC-DC
- Primary Switch in Isolated DC-DC Converter
- Motor Drives

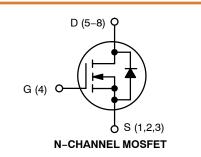
MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

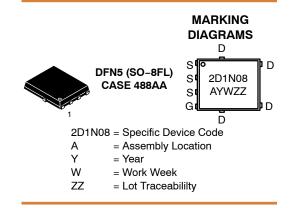
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Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	80	V
Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	$T_C = 25^{\circ}C$	Ι _D	201	А
(Note 1)	$T_{C} = 100^{\circ}C$		142	
Power Dissipation (Note 1)	$T_C = 25^{\circ}C$	PD	164	W
Pulsed Drain Current	T _C = 25°C,	I _{DM}	866	А
Pulsed Source Current (Body Diode)	t _p = 100 μs	I _{SM}	866	
Operating Junction and Storage Temperature Range		T _J , T _{STG}	–55 to +175	°C
Source Current (Body Diode)		I _S	248	А
Single Pulse Avalanche Energy	I _{PK} = 58 A (Note 3)	E _{AS}	168	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- The entire application environment impacts the thermal resistance values shown. They are not constants and are only valid for the particular conditions noted.
- Actual continuous current will be limited by thermal and electromechanical application board design.
- 3. EAS of 168 mJ is based on started T_J = 25°C, I_{AS} = 58 A, V_{DD} = 64 V, V_{GS} = 10 V, 100% avalanche tested.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	1.9 mΩ @ 10 V	201 A





ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS2D1N08XT1G	DFN5 (Pb–Free)	1500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case		0.91	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 4 and 5)	$R_{\theta JA}$	39	

4. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu. 5. $R_{\theta JA}$ is determined by the user's board design.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

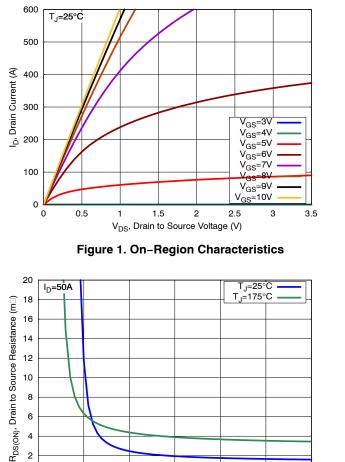
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•					•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA		80			V
Drain-to-Source Breakdown Voltage (transient)	${\Delta V_{(BR)DSS} / \over \Delta T_J}$	I _D = 1 mA, Referenced to 25C			31.6		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}$ $T_J = 25^{\circ}\text{C}$				1	μΑ
		T _J = 125°C			250		
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = 20 V, V _E	_{DS} = 0 V			100	nA
ON CHARACTERISTICS							
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _E	₀ = 50 A		1.7	1.9	mΩ
		V _{GS} = 6 V I _D	= 25 A		2.5	3.8	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 252 μA	2.4		3.6	V
Negative Threshold Temperature Coefficient	${\Delta V_{GS(TH)}}/{\Delta T_J}$	$V_{GS}=V_{DS},I_{D}=252\;\mu\text{A},$			-7.5		mV/°C
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 50 A			158		S
CHARGES AND CAPACITANCES	•	•					•
Input Capacitance	C _{ISS}	V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz			4470		pF
Output Capacitance	C _{OSS}				1290		
Reverse Transfer Capacitance	C _{RSS}				20		
Output Charge	Q _{OSS}				93		
Total Gate Charge	Q _{G(TOT)}	V_{DD} = 40 V, I _D = 50 A, V _{GS} = 6 V			39		nC
					63		
Threshold Gate Charge	Q _{G(TH)}	V _{DD} = 40 V, I _D = 50 A, V _{GS} = 10 V			14		
Gate-to-Source Charge	Q _{GS}				21		nC
Gate-to-Drain Charge	Q _{GD}				10		
Gate Plateau Voltage	V _{GP}				4.7		V
Gate Resistance	R _G	f = 1 MHz			0.8		Ω
SWITCHING CHARACTERISTICS				-		-	
Turn-On Delay Time	t _{d(ON)}	Resistive Load, V_{GS} = 0/10 V, V_{DD} = 40 V, I_D = 50 A, R_G = 2.5 Ω			29		
Rise Time	t _r				9		
Turn-Off Delay Time	t _{d(OFF)}				42		ns
Fall Time	t _f				7		1

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) (continued)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS								
Forward Diode Voltage	V_{SD}	I _S = 50 A, V _{GS} = 0 V	$T_J = 25^{\circ}C$		0.82	1.2	v	
			T _J = 125°C		0.66			
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, I _S = 50 A, dIS/dt = 1000 A/μs, V _{DD} = 40 V			26			
Charge Time	t _a				15		ns	
Discharge Time	t _b				11			
Reverse Recovery Charge	Q _{RR}				202		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



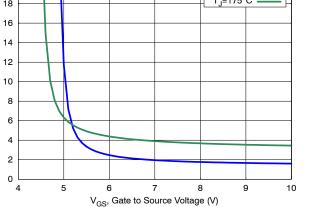
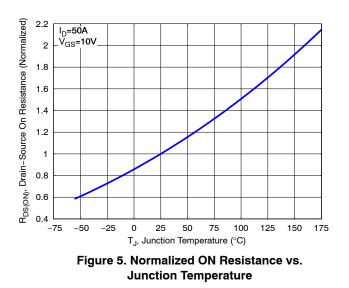
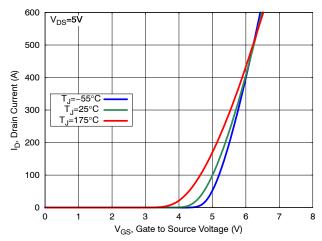


Figure 3. On-Resistance vs. Gate Voltage







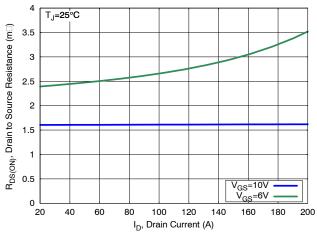
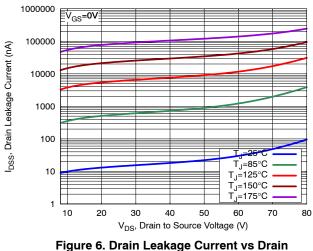
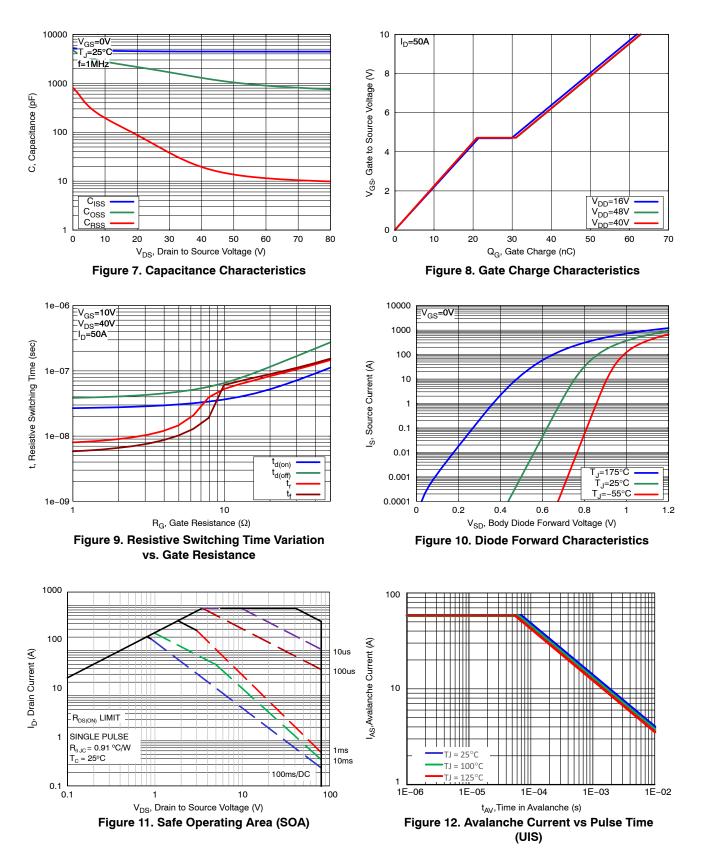


Figure 4. On-Resistance vs. Drain Current

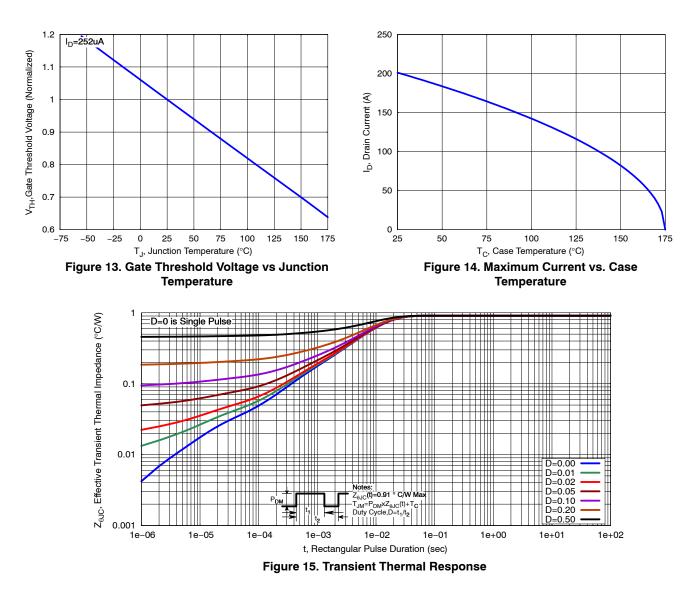


Voltage

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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